Cylindrical Surface Mount Metal Glaze™ Compliant Terminal Resistors





- · Lead free, RoHS compliant
- Uses standard IRC 2512, 3610 solder pads
- · Ideal for automotive and other harsh thermal applications
- Uncompromising Metal Glaze[™] performance gives excellent surge performance
- Capped terminals provide mechanical compliance-relief from board vs. component TCE mismatch



Electrical Data

IRC Type	Industry Standard Footprint	Power Rating @ 70°C (Watts)	Resistance Range (Ohms)	Tolerance (±%)¹	TCR (±ppm/°C)	Operating Voltage (V)	Maximum Voltage (V)
SMC-1	2512	1.0	0.5 to 1M	1, 2, 5	100	350	650
SMC-2	3610	2.0	0.5 to 2M	1, 2, 5	100	500	1000

Notes

Environmental Data

Characteristics	Maximum Change	Test Method	
Temperature Coefficient (ppm/°C)	As specified	MIL-PRF-55342E Par 4.7.9 (-55°C to +125°C)	
Thermal Shock	±0.5% +0.01Ω	MIL-PRF-55342E Par 4.7.3 (-65°C to +150°C)	
Low Temperature Operation	±0.25% +0.01Ω	MIL-PRF-55342E Par 4.7.4 (-65°C @ working voltage)	
Short Time Overload	$\pm 0.5\% +0.01Ω$ $\pm 1\%$ for (R>100KΩ)	MIL-PRF-55342E Par 4.7.5 (2.5 x \sqrt{PxR} for 5 seconds)	
High Temperature Exposure	±0.5% +0.01Ω	MIL-PRF-55342E Par 4.7.6 (+150°C for 100 hours)	
Resistance to Bonding	±0.25% +0.01Ω	MIL-PRF-55342E Par 4.7.7 (Reflow soldered to board @ 260°C for 10 seconds)	
Solderability	95% minimum coverage	MIL-STD-202, Method 208 (245°C for 5 seconds)	
Moisture Resistance	±0.5% +0.01Ω	MIL-PRF-55342E Par 4.7.8 (10 cycles, total 240 hours)	
Life Test	±0.5% +0.01Ω	MIL-PRF-55342E Par 4.7.10 (2000 hours @ 70°C intermittent)	
Terminal Adhesion Strength	±1% +0.01 no mechanical damage	1200 gram push from underside of mounted chip for 60 seconds	
Resistance to Board Bending	±1% +0.01 no mechanical damage	Chip mounted in center of 90mm long board, deflected 5mm so as to exert pull on chip contacts for 10 seconds	
Operating Temperature	-55°C to +150°C		

General Note

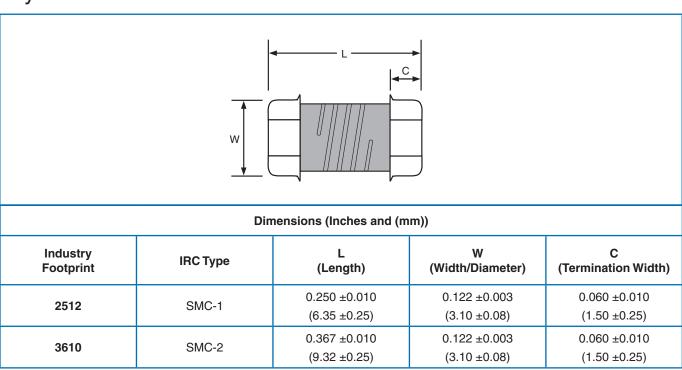
IRC reserves the right to make changes in product specification without notice or liability. All information is subject to IRC's own data and is considered accurate at time of going to print. A subsidiary of TT electronics plc SMC Series Issue July 2009 Sheet 1 of 3

¹ For tolerances below ±1%, please contact factory.

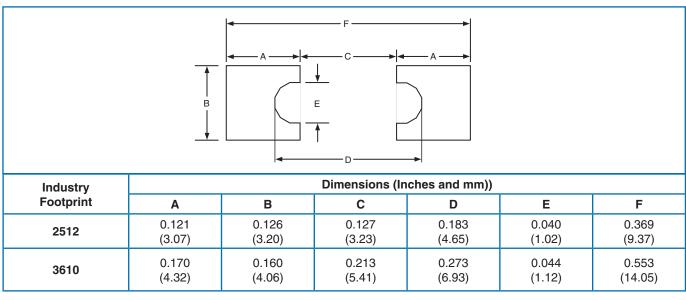
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Physical Data



Recommended Solder Pad Dimensions (Reflow):

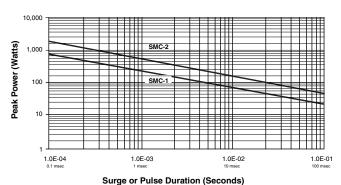


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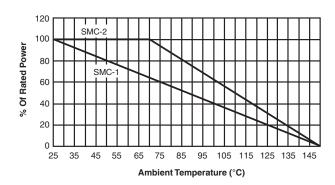


Surge Capabilities

SMC Series Surge Capability for Non-repetitive or Low-Repetition Rate Surges



Power Derating Curve



Standard Reel Packaging per EIA-481:

Industry Footprint	Reel Diameter*	Quantity Per Reel	Carrier Tape Width	Component Pitch
2512	13″	5,000 max.	12mm	4mm
3610	7"	1,500 max.	24mm	4mm

^{*}The 13" reel is considered standard and will be supplied unless otherwise specified

Ordering Data

